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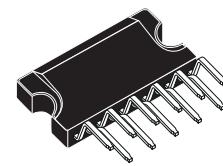
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12 +12W STEREO AMPLIFIER WITH MUTING

- WIDE SUPPLY VOLTAGE RANGE
- HIGH OUTPUT POWER
12+12W @ $V_s=28V$, $R_L = 8\Omega$, THD=10%
- MUTE FACILITY (POP FREE) WITH LOW CONSUMPTION
- AC SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION



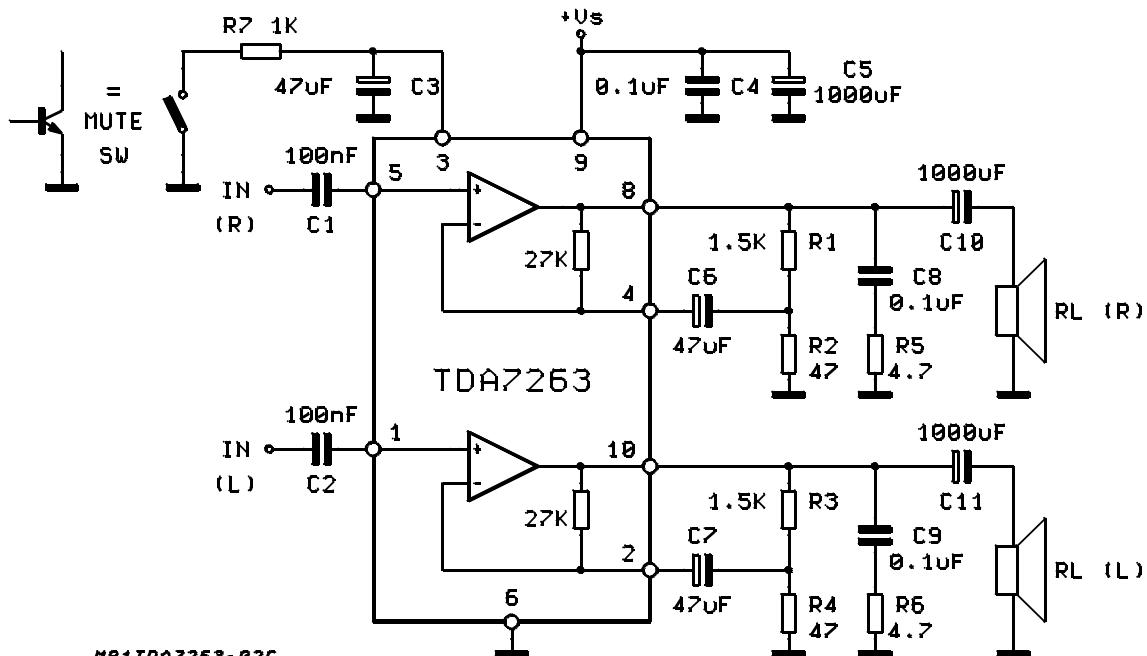
Clipwatt11

ORDERING NUMBER:TDA7263

DESCRIPTION

The TDA7263 is class AB dual audio power amplifier assembled in the new Clipwatt package, specially designed for high quality sound application as HI-FI music centers and stereo TV sets.

TEST AND APPLICATION CIRCUIT

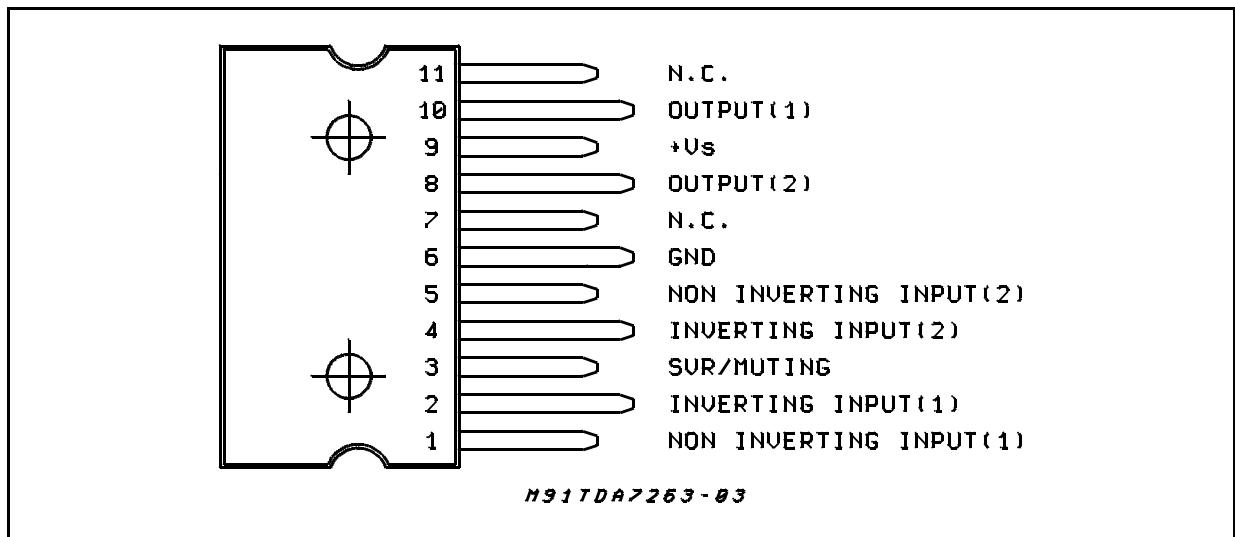


TDA7263

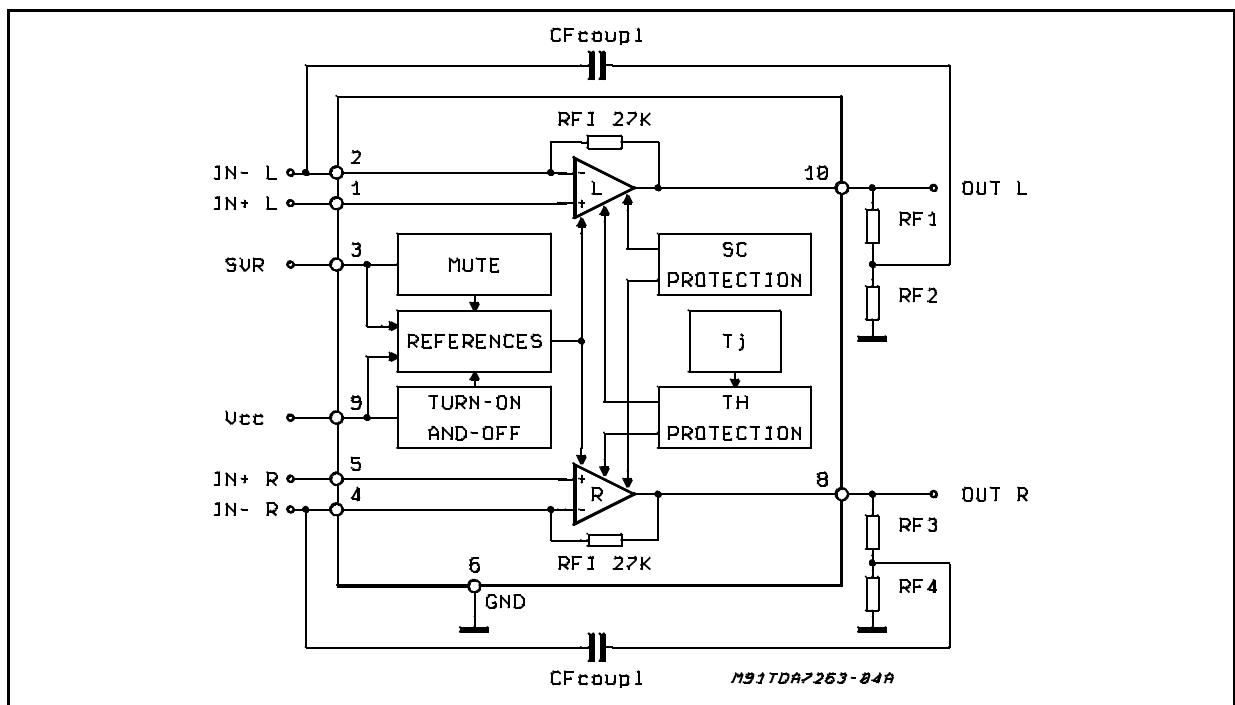
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_S	Supply Voltage without Load	35	V
I_O	Output Peak Current (repetitive $f > 20\text{Hz}$)	2	A
P_{tot}	Total Power Dissipation ($T_{\text{case}} = 70^\circ\text{C}$)	25	W
T_{op}	Operating Temperature Range	0 to 70	$^\circ\text{C}$
$T_{\text{stg},\text{Tj}}$	Storage & Junction Temperature	-40 to 150	$^\circ\text{C}$

PIN CONNECTION (Top view)



BLOCK DIAGRAM



THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th\ j-case}$	Thermal resistance junction to case	3	°C/W

ELECTRICAL CHARACTERISTICS (Refer to the stereo test and application circuit, $V_S = 28V$; $R_L = 8\Omega$; $G_V = 30dB$; $f = 1KHz$; $T_{amb} = 25^\circ C$ unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_S	Supply Voltage		10		30	V
V_O	Quiescent Output Voltage			13.5		V
I_q	Total Quiescent Current			70	95	mA
P_O	Output Power (RMS)	$d = 10\%$ $T_{amb} = 85^\circ C$ $d = 1\%$	10	12 9.5		W W
d	Total Harmonic Distortion	$P_O = 1W$, $f = 1kHz$ $f = 100Hz$ to $10KHz$; $P_O = 0.1$ to $8W$		0.02	0.2 0.5	%
CT	Cross Talk	$R_S = 10K\Omega$; $f = 1KHz$		70		dB
		$R_S = 10K\Omega$; $f = 10KHz$		60		dB
R_I	Input Resistance		100	200		$K\Omega$
f_L	Low Frequency Roll-off (-3dB)			40		Hz
f_H	High Frequency Roll-off (-3dB)			80		KHz
eN	Total Input Noise Voltage	A Curve; $R_S = 10K\Omega$		1.5		mV
		$f = 22Hz$ to $22KHz$; $R_S = 10K\Omega$		3	10	μV
SVR	Supply Voltage Rejection (each channel)	$R_S = 10K\Omega$; $f = 100Hz$; $V_r = 0.5V$	45	60		dB
T_j	Thermal Shutdown Junction Temperature			145		$^\circ C$
MUTE FUNCTION						
VT_{MUTE}	Mute Threshold		1	1.6		V
VT_{PLAY}	Play Threshold			4.5		V
ATT _{AM}	Mute Attenuation		70	100		dB
I_{qMUTE}	Quiescent Current @ Mute			7	10	mA

TYPICAL CHARACTERISTICS (referred to the typical Application Circuit, $V_S = 28V$, $R_L = 8\Omega$, unless otherwise specified)

Figure 1: Output Power vs. Supply Voltage

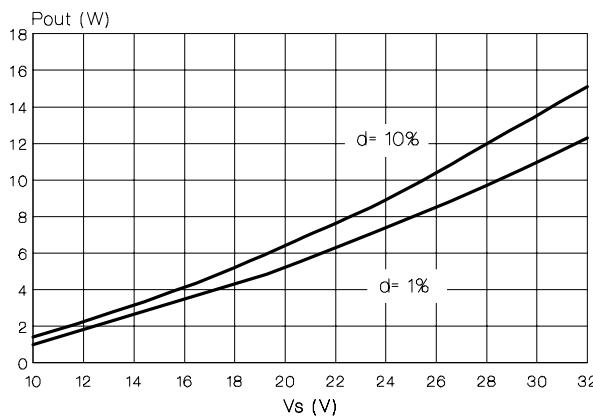
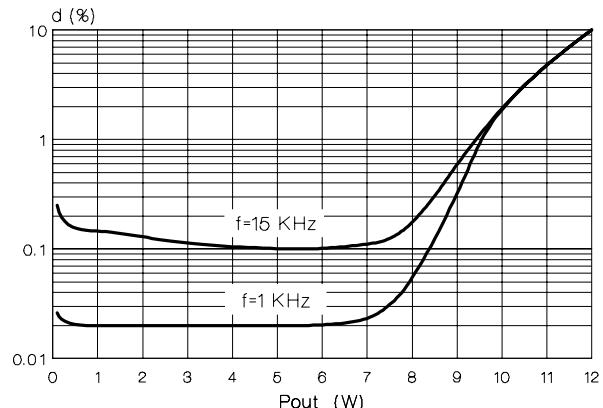


Figure 2: Distortion vs. Output Power



TDA7263

Figure 3: Quiescent Current vs. Supply Voltage

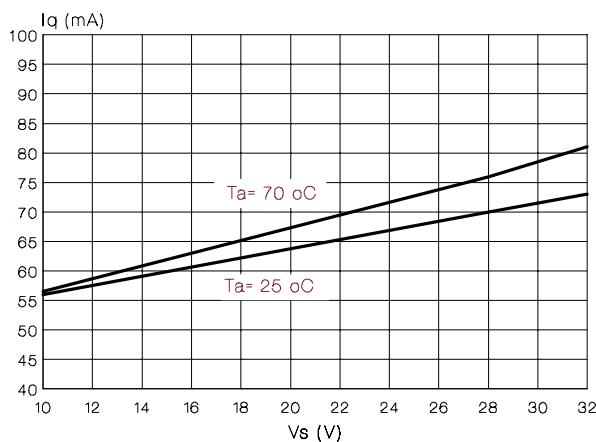


Figure 4: Supply Voltage Rejection vs. Frequency

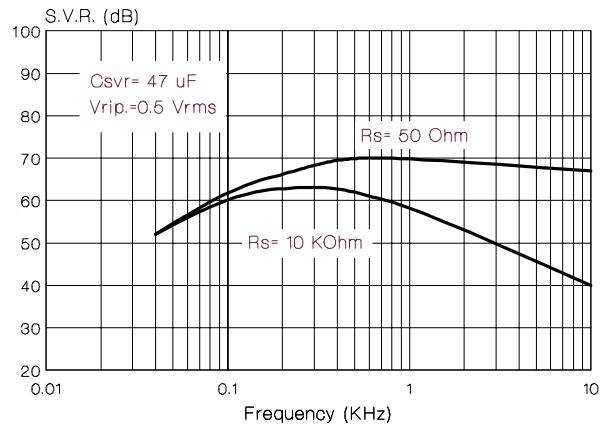


Figure 5: Crosstalk vs. Frequency

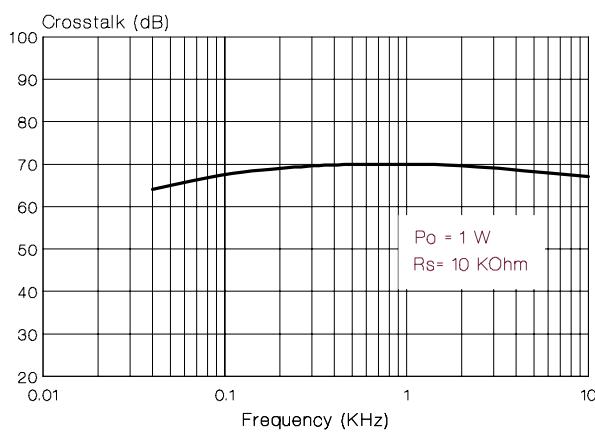


Figure 6: Output Attenuation & Quiescent Current vs. V_{pin3}

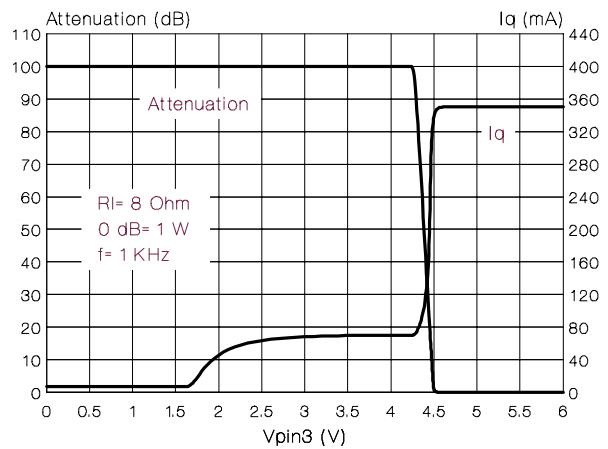


Figure 7: Total Power Dissipation vs. Output Power

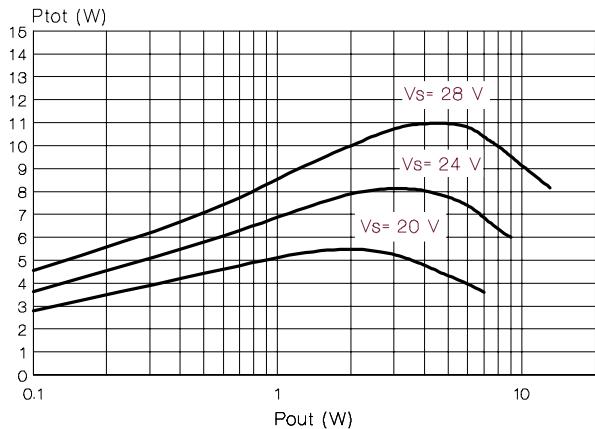
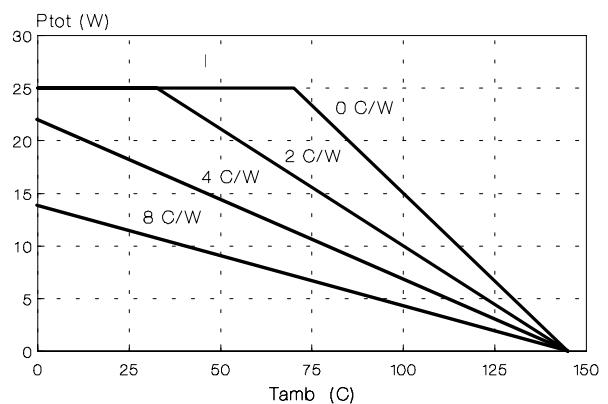


Figure 8: Maximum allowable Power dissipation vs. Ambient Temperature



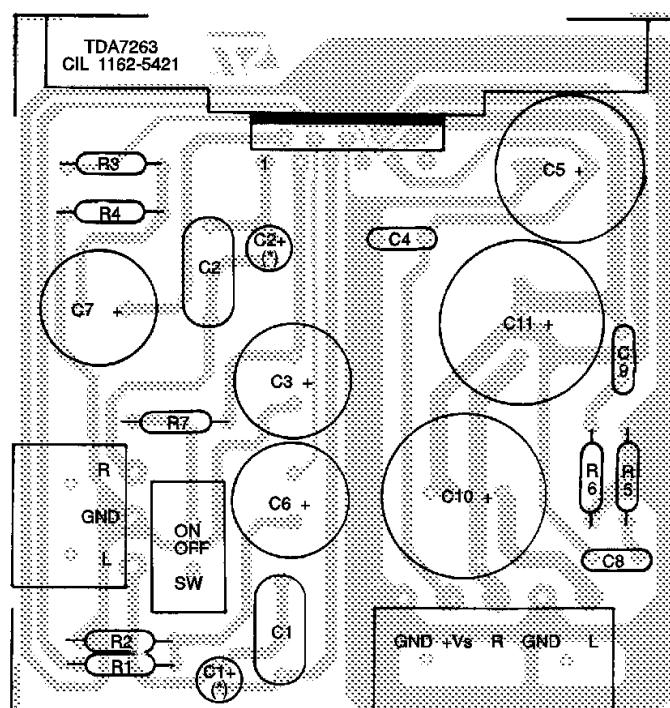
APPLICATION SUGGESTION

The recommended values of the components are those shown on the typical application circuit. Different values can be used; the following table can help the designer.

Component	Recomm. Value	Purpose	Larger Than	Smaller Than
R1 and R3	1.5KΩ	Close loop gain setting (*)	Increase of gain	Decrease of gain
R2 and R4	47Ω	Close loop gain setting (*)	Decrease of gain	Increase of gain
R5 and R6	4.7Ω	Frequency stability	Danger of oscillations	
C1 and C2	100nF	Input DC decoupling	Higher SVR	Higher low frequency cutoff
C3	47µF	- Ripple Rejection - Mute time constant	Increase of the Switch-on time	- Degradation of SVR - Worse turn-off pop by muting
C4	100nF	Supply Voltage Bypass		Danger of oscillations
C5	1000µF	Supply Voltage Bypass		
C6 and C7	47µF	Feedback input DC decoupling	Increase of the Switch-on time	Danger of Switch-on time
C8 and C9	0.1µF	Frequency stability		Danger of oscillations
C10 and C11	1000µF	Output DC decoupling		Higher low-frequency cut-off

(*) Closed loop gain must be higher than 26dB

Figure 9: P.C. Board and Component Layout (1:1 scale)



Note: Use either C1, C2 (Polyester) or C1(*), C2(*) (Electrolytic) but not both.

BUILT-IN PROTECTION SYSTEMS**THERMAL SHUT-DOWN**

The presence of a thermal limiting circuit offers the following advantages:

- 1-an overload on the output (even if it is permanent), or an excessive ambient temperature can be easily withstood.
- 2-the heatsink can have a smaller factor of safety compared with that of a conventional circuit. There is no device damage in the case of excessive junction temperature; if for any reason the junction temperature increases up to 145°C. the thermal shutdown simply re-

duces the output power and therefore the power dissipation.

The maximum allowable power dissipation depends upon the thermal resistance junction-ambient. Figure 8 shows the dissipable power as a function of ambient temperature for different heatsink thermal resistance.

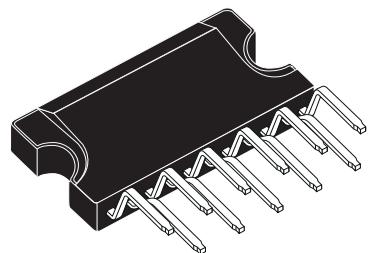
SHORT CIRCUIT (AC CONDITIONS)

The TDA7263 can withstand accidental short circuits across the speaker made by a wrong connection during normal play operation.

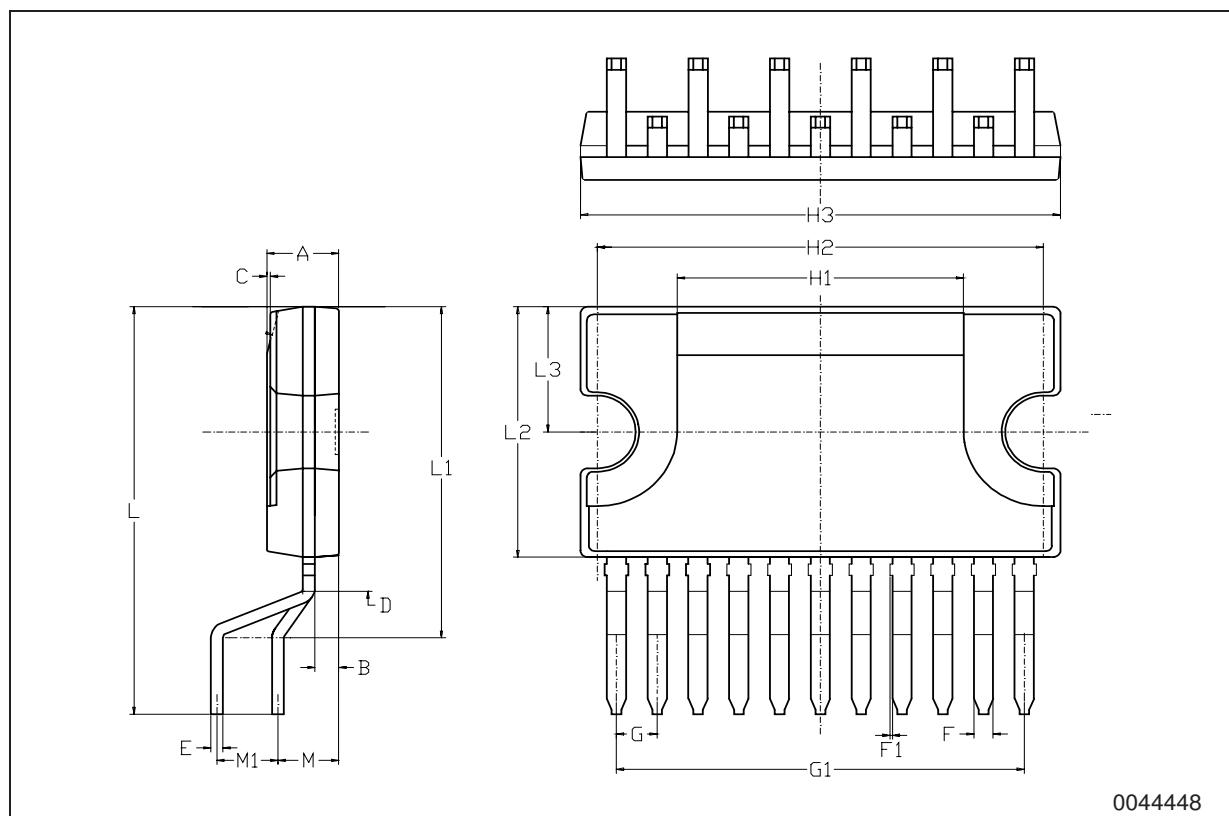
DIM.	mm			inch		
	MIN.	_TYP.	MAX.	MIN.	_TYP.	MAX.
A			3.2			0.126
B			1.05			0.041
C		0.15			0.006	
D		1.5			0.059	
E	0.49		0.55	0.019		0.002
F	0.77	0.8	0.88	0.030	0.031	0.035
F1			0.15			0.006
G	1.57	1.7	1.83	0.062	0.067	0.072
G1	16.87	17	17.13	0.664	0.669	0.674
H1		12			0.480	
H2		18.6			0.732	
H3	19.85			0.781		
L		17.9			0.700	
L1		14.55			0.580	
L2	10.7	11	11.2	0.421	0.433	0.441
L3		5.5			0.217	
M		2.54			0.100	
M1		2.54			0.100	

OUTLINE AND MECHANICAL DATA

Weight: 1.80gr



Clipwatt11



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